

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
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HIDEICHIRO KAWAGUCHI	01/06/2016
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14908391
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ATTORNEY DOCKET NUMBER:	61-1059
NAME OF SUBMITTER:	PATRICIA E. HONG
SIGNATURE:	/Patricia E. Hong /
DATE SIGNED:	01/28/2016
Total Attachments: 1	
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ASSIGNMENT

WHEREAS, hereinafter (collectively) referred to as the Assignor, have invented certain new and useful improvements in

REINFORCED THERMOPLASTIC RESIN COMPOSITION AND MOLDED ARTICLE THEREOF

for which an application for Letters Patent of the United States has been prepared,

- ☐ the Declaration for said application executed on even date herewith;
- ☐ said application having been filed in the United States Patent and Trademark Office on _____ and accorded Serial Number _____, and was amended on _____ (if applicable);
- ☒ said application having been filed under the Patent Cooperation Treaty on October 5, 2015 and _____ accorded Application No. PCT/JP2015/078168, the United States of America being designated;

WHEREAS, UMG ABS, LTD., 8-1, Akashi-cho, Chuo-ku, Tokyo 104-6591 Japan

hereinafter referred to as the Assignee, is desirous of acquiring the entire right, title and interest in and to the aforesaid invention and in and to any Letters Patent of the United States or any foreign country which may be granted therefor;

NOW THEREFORE, for good and valuable consideration the Assignor by these presents do sell, assign, and transfer unto the Assignee, its successors, legal representatives and assigns, the full and exclusive right to the invention as described in said application, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations and extensions thereof;

AND said Assignor authorizes and requests the Commissioner of Patents and Trademarks or any other proper officer or agency of any country to issue all said Letters Patent to said Assignee;

AND said Assignor warrants and covenants that I/We have full right to convey the entire interest herein assigned and that I/We have not executed and will not execute any instrument or assignment in conflict herewith;

AND said Assignor agrees to communicate to said Assignee or its representatives any facts known to me/us respecting said invention, to execute all divisional, continuation, reissue and foreign applications, sign all lawful documents and make all rightful oaths relating to said invention, and to testify in any judicial or administrative proceeding and generally do everything possible to aid the said Assignee to obtain and enforce said Letters Patent in the United States or any foreign country when requested so to do by said Assignee.

IN WITNESS WHEREOF, I/We have hereunto set my/our hand and seal.

Date: January 6, 2016

Signature: Masahito NAKAMOTO
Name: Masahito NAKAMOTO

Date: January 6, 2016

Signature: Hideichiro KAWAGUCHI
Name: Hideichiro KAWAGUCHI